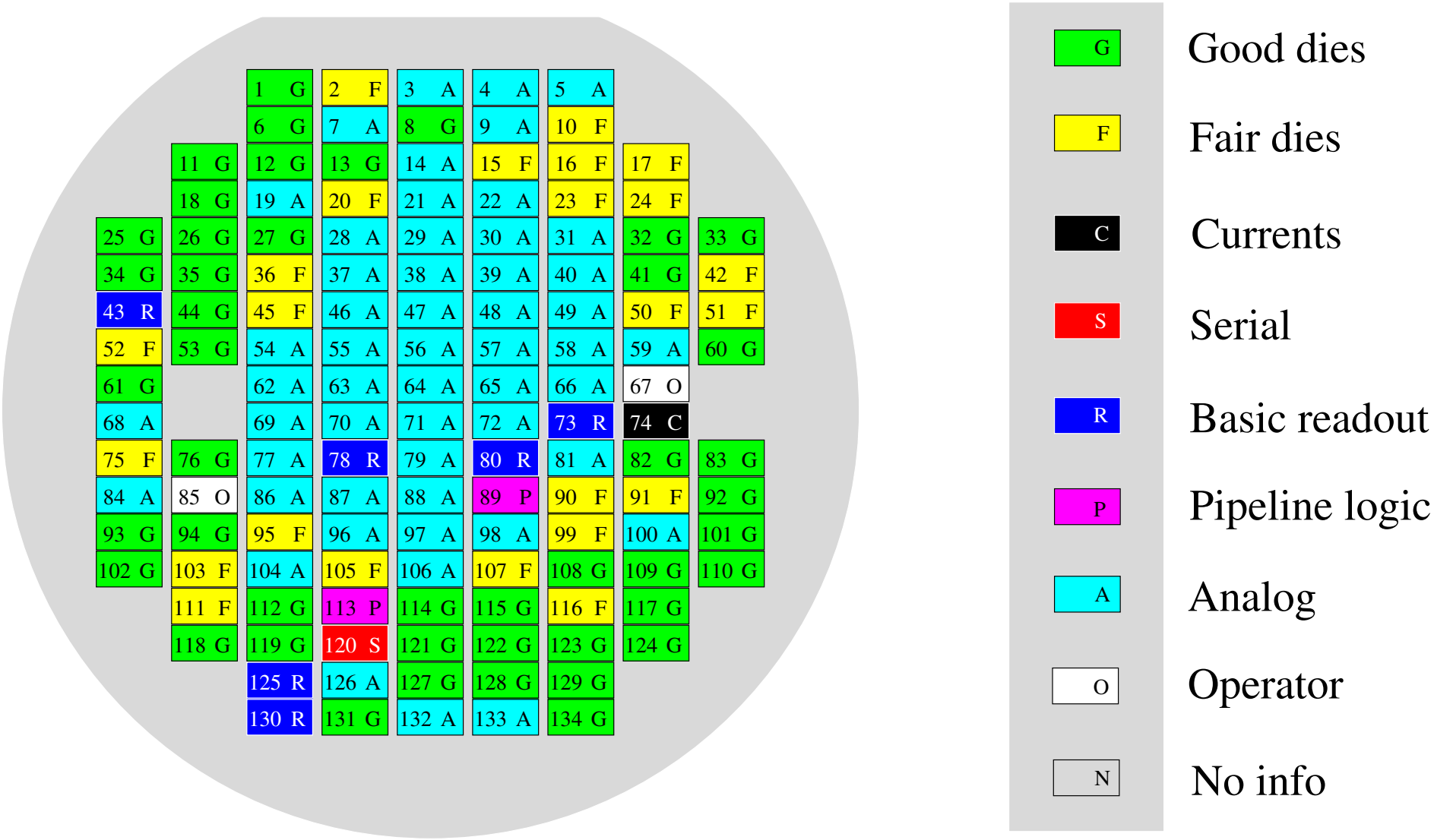
Types of die failures for wafer 169 s/n: Y21316-12-05

Date: 07/06/99